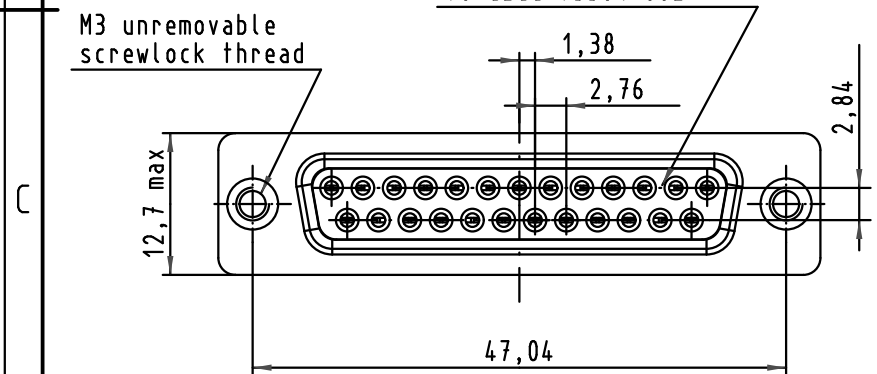
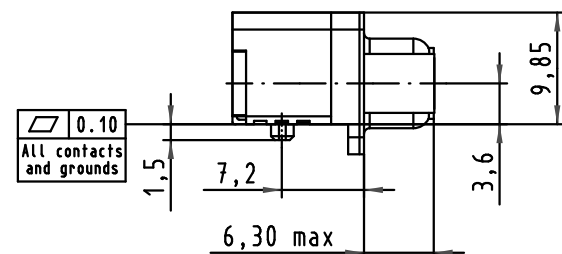


PCB Layout, component side (thickness 1,6mm min.)



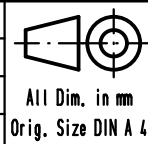
Mating face according to CECC 75301-802



Max. Temperature: 260°C during 10 seconds

09553563619.741	1	M3	Black Insulator	Reel Packaging (160 connectors) see page 2/2
09553566619.741	2			
09553567619.741	3			
Part number	PL	Thread	Index designation	

			Dot.	Name
			Detail.	30Jun2010 ED
			Insp.	
			Stand.	
EC01953	30Jun2010	ED	HARTING EURL F-95972 Paris	
Mod.	Dot.	Name		



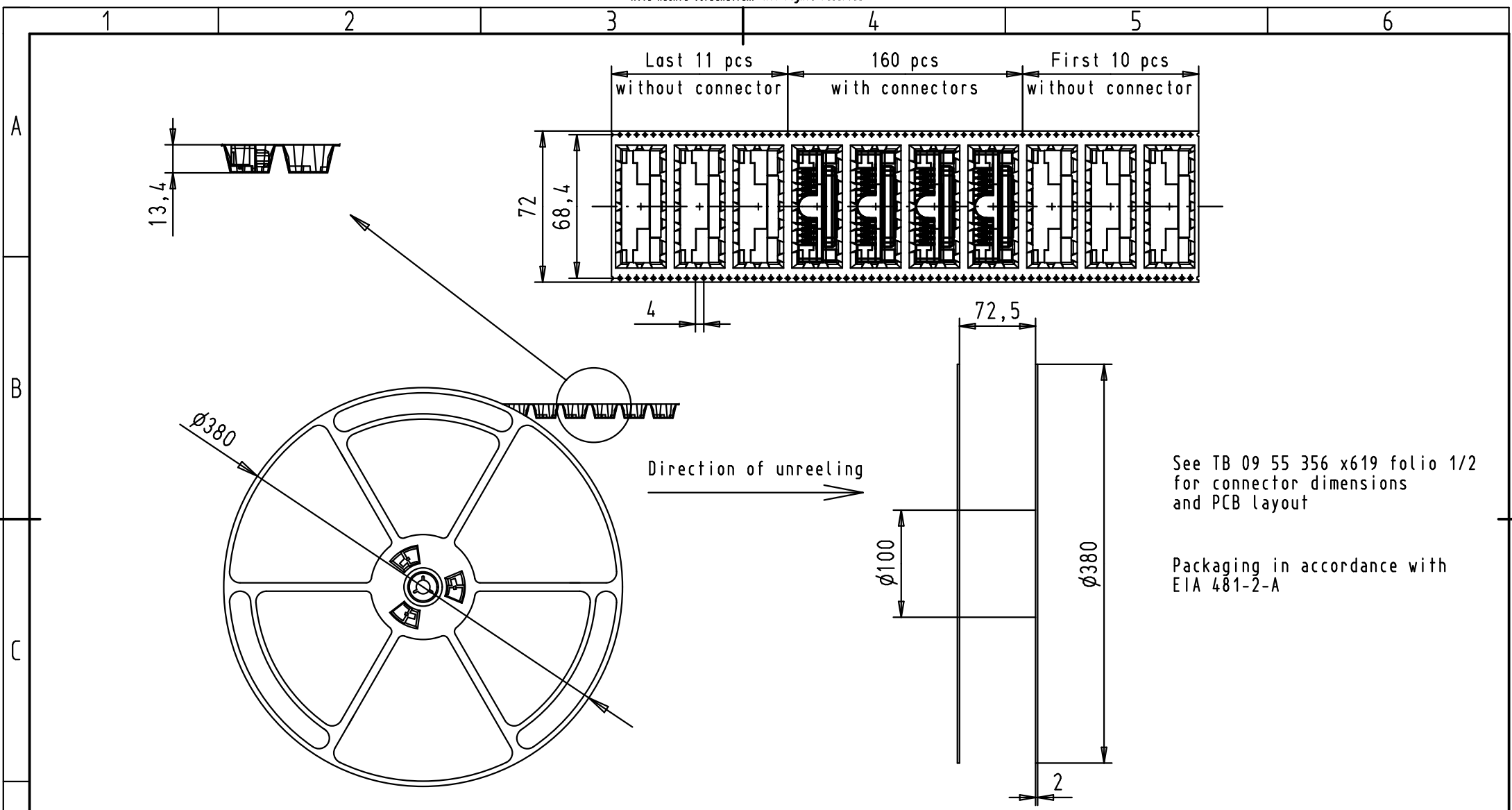
D-SUB SMT
Low Profile Female 25p
with die casted grounds
and M3 unremovable screwlocks

TB 09 55 356 x619

Sub.

Maßstab/
Scale
1,5:1

Blatt/
Page
1/2



See TB 09 55 356 x619 folio 1/2 for connector dimensions and PCB layout

Packaging in accordance with EIA 481-2-A

				Dot.	Name
				Detail.	30Jun2010 ED
				Insp.	
				Stand.	



D-SUB SMT
Low Profile Female 25p
with die casted grounds
and M3 unremovable screwlocks

Maßstab/
Scale

09553563619.741	1	M3	Black Insulator	Reel Packaging (160 connectors)
09553566619.741	2			
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Part number	PL	Thread	Index designation	

EC01953	30Jun2010	ED
Mod.	Dot.	Name

HARTING EURL
F-95972 Paris



TB 09 55 356 x619

Blatt/ Page
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